

## IN THE SPECIFICATION

Please Amend paragraph [0007] to read as follows:

[0007] Several sputtering processes and apparatus with which the invention may be usable are disclosed in Bergmann, et al., U.S. Pat. Nos. 4,889,772 and 4,961,831; Shagun, et al., U.S. Pat. No. 4,961,832; Shimamura, et al., U.S. Pat. No. 4,963,239; Nobutani, et al., U.S. Pat. No. 4,964,962; Arita, U.S. Pat. No. 4,964,968; Kusakabe, et al., U.S. Pat. No. 4,964,969 and Hata, U.S. Pat. No. 4,971,674; and the references referred to therein; also, sputtering targets are discussed ~~also~~ in Fukasawa, et al. U.S. Pat. Nos. 4,963,240 and 4,966,676 ; ~~and Archut, et al., U.S. Pat. No. 4,966,676~~ . These disclosures of sputtering processes and apparatus as well as sputtering targets are expressly incorporated herein by reference. Additional background on sputtering is presented by U.S. Pat. Nos. 6,402,912; 6,494,999, and 6,585,870 expressly incorporated herein by reference.

Please Amend paragraph [0067] to read as follows:

[0067] The hot forging of plates cast in ~~graphite~~ metal molds is primarily carried out in open flat dies in accordance with the present invention. The optimum forging parameters need to be determined for each alloy before the actual forging operation is carried out.